

HSF RoHS

SPECIFICATIONS

Current Rating:3.0AMP

Contact Resistance:10mΩ Max

Dielectric Strength:Min 1000V AC RMS

Operation Temperature:-40℃ to +105℃

Contact Material:Brass

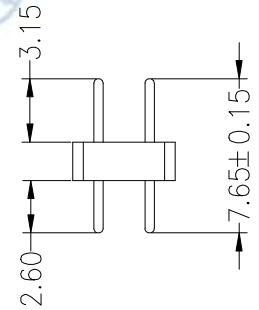
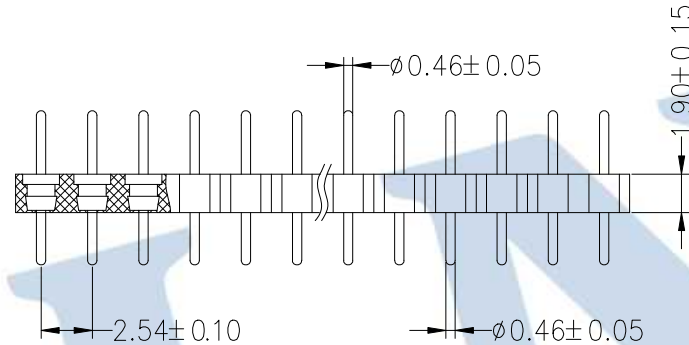
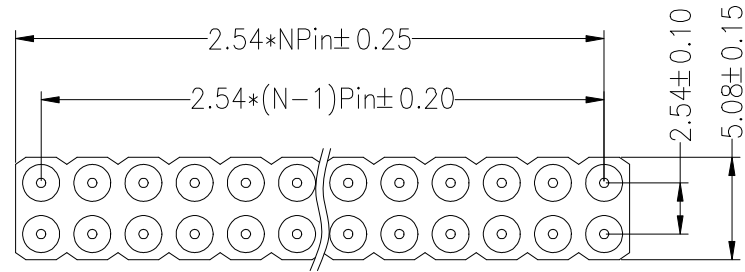
Contact Plating:Au Over Ni

Insulator Material:Polyester(UL94V-0)

Standard: PPS

Soldering Temperature:

260℃±5℃ For 5~10 Second



Ordering Information

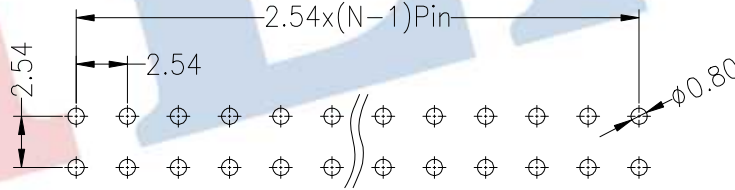
3610 19 2 XX S XX 076 XX

No. of Pins
Per Row
NPin
N=02~40

Contact Plating
G1:1U" Gold
G2:1.5U" Gold
G3:2U" Gold
G4:3U" Gold
G5:5U" Gold
S0:Gold Flash/Tin
SN:Tin

Length
076=7.65mm

Code Stream



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

				OPERATION		DRAW	Wei Chen	2022.05.05	SCALE	FIT	JILN ® 深圳市锦凌电子有限公司 SHENZHEN JINLING ELECTRONICS CO.,LTD Tel: 86-755-27483253 Fax: 86-755-2997-5588	
				X.X	±0.30				UNIT	mm		
				X.XX	±0.20	CHECK			SIZE	A4		
				X.XXX	±0.10				SHEET	1/1		
A0	2022.05.05	NEW DRAWING		Angle	±3°	APPROVE			PROJ.	1/1	PART NO.	
REV	DATE	MODIFICATION DESCRIPTION		DIM	TOL						TITLE:	
1		2	3	4	5	6	7	8	9		3610192XXSXX076XX	
											2.54x1.9 双排双头针 L=7.65 针尖0.46	